

Pb Free Plating Product

APT30D100BCA/APT30D100BCAG



2*18A/1000V Heatsink Dual Anode Common Ultra Fast Recovery Rectifiers

APPLICATION

- Freewheeling, Snubber, Clamp
- Inversion Welder
- PFC
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- UPS

PRODUCT FEATURE

- Ultrafast Recovery Time
- Soft Recovery Characteristics
- Low Recovery Loss
- Low Forward Voltage
- High Surge Current Capability
- Low Leakage Current

TO-3PN/TO-3PB-SQ

② Bottom Side Metal Heat Sink(Back of Case-Anode)

Internal Configuration

Positive Common Cathode Suffix "CT" Suffix "CTG"	Negative Common Anode Suffix "CA" Suffix "CAG"	Doubler Tandem Polarity Suffix "CD" Suffix "CDG"	Series Tandem Polarity Suffix "HB" Suffix "HBG"

GENERAL DESCRIPTION

APT30D100BCA/APT30D100BCAG using the latest FRED FAB process(planar passivation pellet) with ultrafast and soft recovery characteristics.

MAXIMUM RATINGS All Ratings Per Leg: T_C = 25°C unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT30D100BCA/APT30D100BCAG	UNIT
V _R	Maximum D.C. Reverse Voltage	1000	Volts
V _{RRM}	Maximum Peak Repetitive Reverse Voltage		
V _{RWM}	Maximum Working Peak Reverse Voltage		
I _{F(AV)}	Maximum Average Forward Current (T _C = 105°C, Duty Cycle = 0.5)	18	Amps
I _{F(RMS)}	RMS Forward Current (Square wave, 50% duty)	27	
I _{FSM}	Non-Repetitive Forward Surge Current (T _J = 45°C, 8.3ms)	210	
T _J , T _{STG}	Operating and StorageTemperature Range	-55 to 175	°C
T _L	Lead Temperature for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
V _F	Forward Voltage	I _F = 30A		1.9	Volts
		I _F = 60A		2.2	
		I _F = 30A, T _J = 125°C		1.7	
I _{RM}	Maximum Reverse Leakage Current	V _R = V _R Rated		250	μA
		V _R = V _R Rated, T _J = 125°C		500	
C _T	Junction Capacitance, V _R = 200V		32		pF

DYNAMIC CHARACTERISTICS

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
t_{rr}	Reverse Recovery Time	$I_F = 1A$, $di_F/dt = -100A/\mu s$, $V_R = 30V$, $T_J = 25^\circ C$	-	29		ns
t_{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -200A/\mu s$ $V_R = 667V$, $T_C = 25^\circ C$	-	290		
Q_{rr}	Reverse Recovery Charge		-	670		nC
I_{RRM}	Maximum Reverse Recovery Current		-	5	-	Amps
t_{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -200A/\mu s$ $V_R = 667V$, $T_C = 125^\circ C$	-	390		ns
Q_{rr}	Reverse Recovery Charge		-	2350		nC
I_{RRM}	Maximum Reverse Recovery Current		-	11	-	Amps
t_{rr}	Reverse Recovery Time	$I_F = 30A$, $di_F/dt = -1000A/\mu s$ $V_R = 667V$, $T_C = 125^\circ C$	-	160		ns
Q_{rr}	Reverse Recovery Charge		-	3500		nC
I_{RRM}	Maximum Reverse Recovery Current		-	38		Amps

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction-to-Case Thermal Resistance			1.8	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance			40	
W_T	Package Weight		0.22		oz
			5.9		g
Torque	Maximum Mounting Torque			10	lb•in
				1.1	N•m

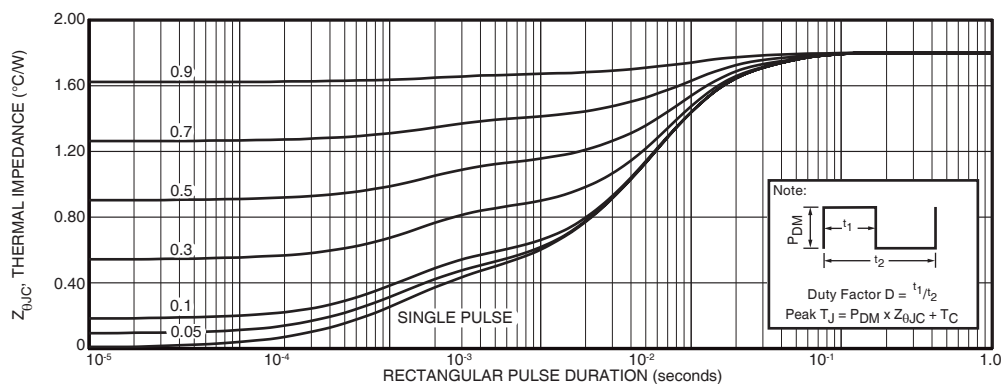


FIGURE 1a. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION

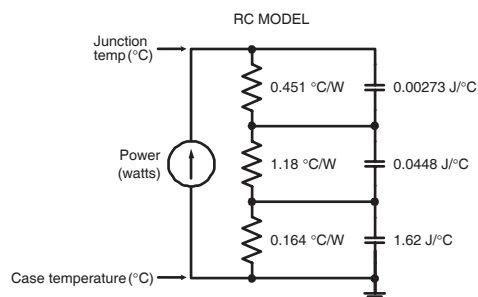


FIGURE 1b. TRANSIENT THERMAL IMPEDANCE MODEL

TYPICAL PERFORMANCE CURVES

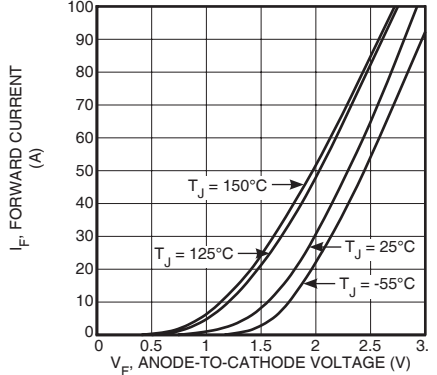


Figure 2. Forward Current vs. Forward Voltage

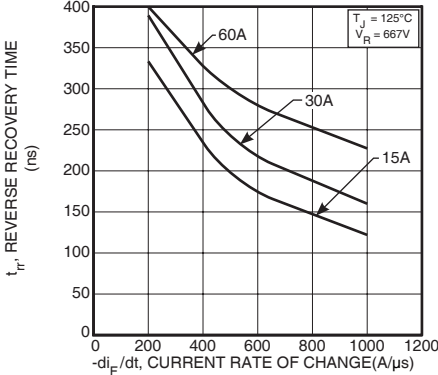


Figure 3. Reverse Recovery Time vs. Current Rate of Change

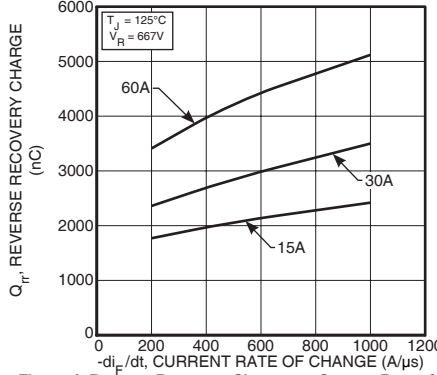


Figure 4. Reverse Recovery Charge vs. Current Rate of Change

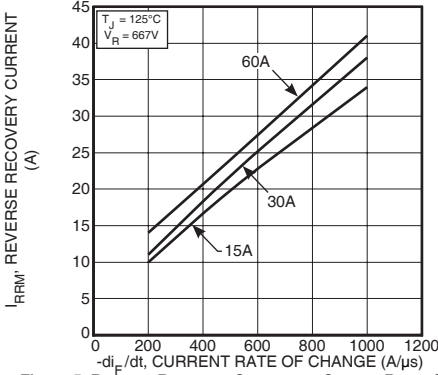


Figure 5. Reverse Recovery Current vs. Current Rate of Change

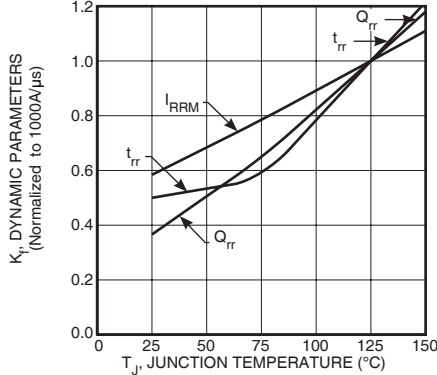


Figure 6. Dynamic Parameters vs. Junction Temperature

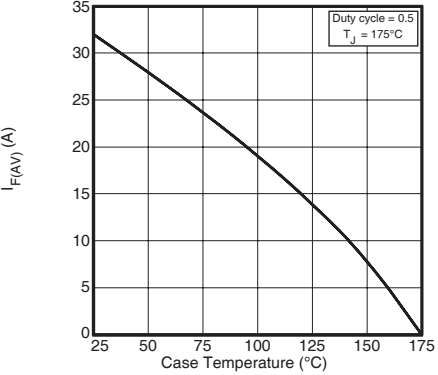


Figure 7. Maximum Average Forward Current vs. Case Temperature

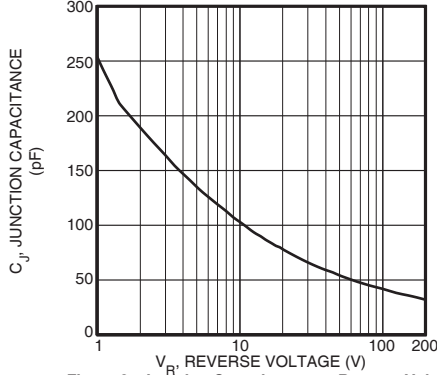


Figure 8. Junction Capacitance vs. Reverse Voltage

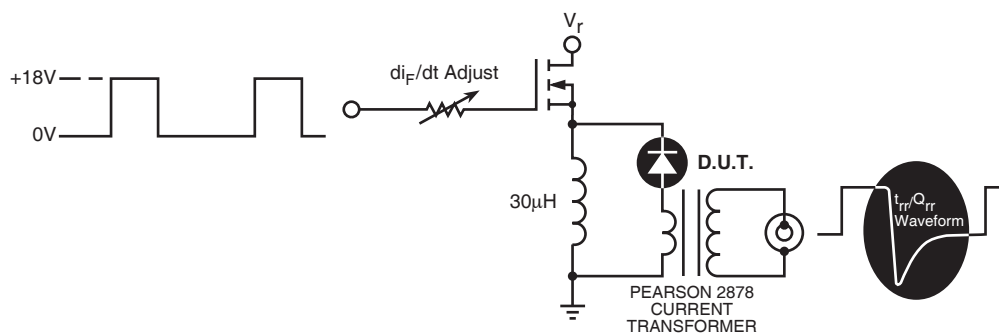


Figure 9. Diode Test Circuit

- ❶ I_F - Forward Conduction Current
- ❷ di_F/dt - Rate of Diode Current Change Through Zero Crossing.
- ❸ I_{RRM} - Maximum Reverse Recovery Current.
- ❹ t_{rr} - Reverse Recovery Time, measured from zero crossing where diode current goes from positive to negative, to the point at which the straight line through I_{RRM} and $0.25 \cdot I_{RRM}$ passes through zero.
- ❺ Q_{rr} - Area Under the Curve Defined by I_{RRM} and t_{rr} .

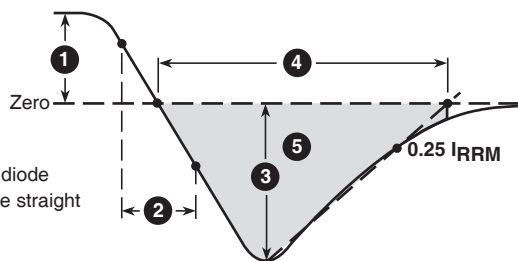
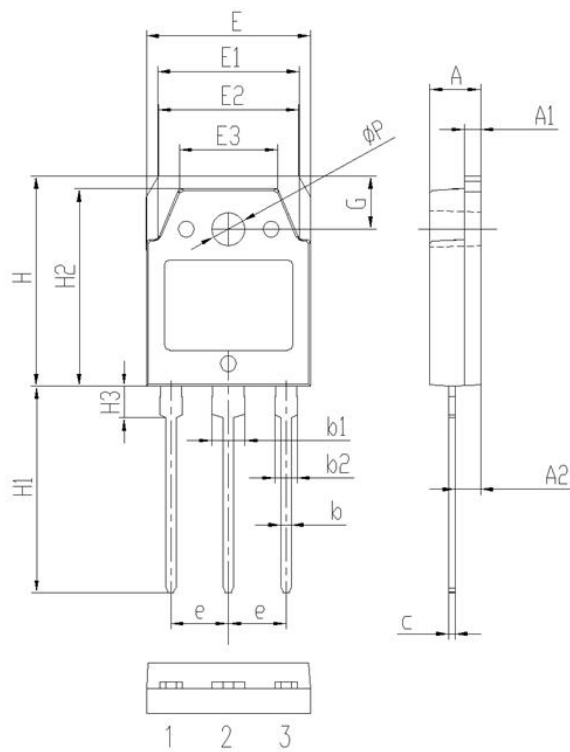


Figure 10, Diode Reverse Recovery Waveform and Definitions

Package Outline

THINKI TO-3PN/TO-3PB-SQ



Symbol	Dimensions(millimeters)	
	Min.	Max.
A	4.60	5.00
A1	1.50	2.00
A2	2.20	2.60
b	0.80	1.20
b1	2.90	3.30
b2	1.90	2.30
c	0.40	0.80
e	5.25	5.65
E	15.3	15.7
E1	13.2	13.6
E2	13.1	13.5
E3	9.10	9.50
H	19.7	20.1
H1	19.1	20.1
H2	18.3	18.7
H3	2.80	3.20
G	4.80	5.20
ΦP	3.00	3.40